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SN74LVC162244 16-BIT BUFFER/DRIVER WITH 3-STATE OUTPUTS SCAS545 – OCTOBER 1995

 Member of the Texas Instruments Widebus™ Family 	DGG OR DL PACKAGE (TOP VIEW)	
 EPIC ™ (Enhanced-Performance Implanted CMOS) Submicron Process 		48 20E
 Output Ports Have Equivalent 26-Ω Series Resistors, So No External Resistors Are Required 	1Y1 2 1Y2 3 GND 4	47 1A1 46 1A2 45 GND
 Typical V_{OLP} (Output Ground Bounce) < 0.8 V at V_{CC} = 3.3 V, T_A = 25°C 	1Y3 [5 1Y4 [6 V _{CC} [7	44 1A3 43 1A4 42 V _{CC}
 Typical V_{OHV} (Output V_{OH} Undershoot) > 2 V at V_{CC} = 3.3 V, T_A = 25°C 	2Y1 [8 2Y2 [9	41 2A1 40 2A2
 ESD Protection Exceeds 2000 V Per MIL-STD-883C, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0) 	GND [] 10 2Y3 [] 11 2Y4 [] 12 3Y1 [] 13	38 2A3 37 2A4
 Latch-Up Performance Exceeds 250 mA Per JEDEC Standard JESD-17 	3Y2 [14 GND [15	34 🛛 GND
 Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors 	3Y3 [16 3Y4 [17 V _{CC} [18	32 3A4 31 V _{CC}
 Package Options Include Plastic 300-mil Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages 	4Y1 19 4Y2 20 GND 21 4Y3 22	30 4A1 29 4A2 28 GND 27 4A3
description	4Y4 23 4OE 24	26 4A3 26 4A4 25 30E
This 16-bit buffer/driver is designed for 2.7-V to		

3.6-V V_{CC} operation.

The SN74LVC162244 is designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. The device can be used as four 4-bit buffers, two 8-bit buffers, or one 16-bit buffer. It provides true outputs and symmetrical active-low output-enable $\overline{(OE)}$ inputs. The outputs, which are designed to sink up to 12 mA, include 26- Ω resistors to reduce overshoot and undershoot.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN74LVC162244 is characterized for operation from -40°C to 85°C.

(each 4-bit buffer)						
INPU	JTS	OUTPUT				
OE	Α	Y				
L	Н	Н				
L	L	L				
н	Х	Z				

FUNCTION TADLE



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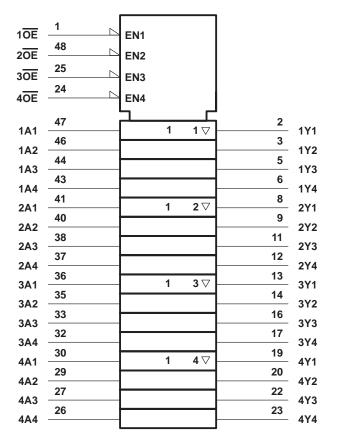
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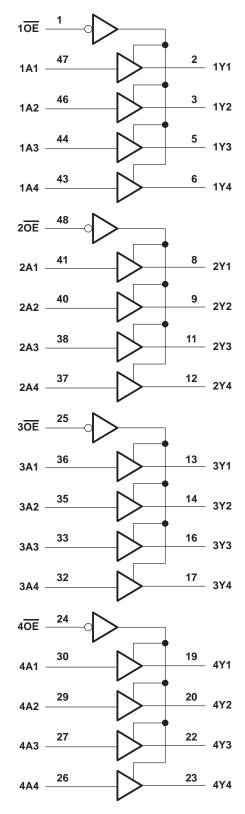
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logic symbol[†]



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.





logic diagram (positive logic)

SN74LVC162244 **16-BIT BUFFER/DRIVER** WITH 3-STATE OUTPUTS SCAS545 - OCTOBER 1995

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC} Input voltage range, V_I (see Note 1) Output voltage range, V_O (see Notes 1 and 2) Input clamp current, I_{IK} ($V_I < 0$) Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$) Continuous output current, I_O ($V_O = 0$ to V_{CC}) Continuous current through V_{CC} or GND Maximum power dissipation at $T_A = 55^{\circ}C$ (in still air) (see Note 3): DGG	$\begin{array}{cccc} -0.5 \mbox{ V to } 4.6 \mbox{ V} \\ & -0.5 \mbox{ V to } \mbox{ V}_{CC} + 0.5 \mbox{ V} \\ & -50 \mbox{ mA} \\ & \pm 50 \mbox{ mA} \\ & \pm 100 \mbox{ mA} \\ package & 1 \mbox{ W} \end{array}$
	ackage 1.4 W
Storage temperature range, T _{stg}	

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

2. This value is limited to 4.6 V maximum.

3. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils. For more information, refer to the Package Thermal Considerations application note in the 1994 ABT Advanced BiCMOS Technology Data Book, literature number SCBD002B.

recommended operating conditions (see Note 4)

			MIN	MAX	UNIT	
Vcc	Supply voltage		2.7	3.6	V	
VIH	High-level input voltage	$V_{CC} = 2.7 V \text{ to } 3.6 V$	2		V	
VIL	Low-level input voltage	$V_{CC} = 2.7 V \text{ to } 3.6 V$		0.8	V	
VI	Input voltage		0	VCC	V	
Vo	Output voltage		0	VCC	V	
	High-level output current	$V_{CC} = 2.7 V$		-8	mA	
ЮН		$V_{CC} = 3 V$		-12		
	Low-level output current	$V_{CC} = 2.7 V$		8	mA	
IOL	V _{CC} = 3 V			12		
$\Delta t/\Delta V$	Input transition rise or fall rate		0	10	ns/V	
TA	Operating free-air temperature		-40	85	°C	

NOTE 4: Unused control inputs must be held high or low to prevent them from floating.



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

P/	ARAMETER	TEST C	ONDITIONS	Vcc†	MIN	typ‡	MAX	UNIT
		I _{OH} = -100 μA		MIN to MAX	V _{CC} -0.2	2		
		I _{OH} = -6 mA,	V _{IH} = 2 V	3	2.4			V
∨он		I _{OH} = -8 mA,	V _{IH} = 2 V	2.7	2			V
		I _{OH} = -12 mA,	V _{IH} = 2 V	3	2			
Vai		I _{OL} = 100 μA		MIN to MAX			0.2	
VOL		I _{OL} = 6 mA,	V _{IL} = 0.8 V	3			0.55	V
		I _{OL} = 8 mA,	V _{IL} = 0.8 V	2.7			0.6	v
		I _{OL} = 12 mA,	V _{IL} = 0.8 V	3			0.8	
II		$V_{I} = V_{CC} \text{ or } GND$		3.6			±5	μA
ll(hold)		V _I = 0.8 V		3	75			
		V _I = 2 V		3	-75			μA
		V _I = 0 to 3.6 V		3.6		:	± 500	
IOZ		$V_{O} = V_{CC}$ or GND		3.6			±10	μΑ
ICC		$V_{I} = V_{CC}$ or GND,	IO = 0	3.6			20	μΑ
∆lCC		One input at V _{CC} – 0.6 V,	Other inputs at V _{CC} or GND	2.7 V to 3.6 V			500	μA
Ci	Control inputs	$V_{I} = V_{CC}$ or GND		3.3		2.5		pF
Co	A or B ports	$V_{O} = V_{CC}$ or GND		3.3		3.5		pF

[†] For conditions shown as MIN or MAX, use the appropriate values under recommended operating conditions.

[‡] All typical values are at V_{CC} = 3.3 V, T_A = 25° C.

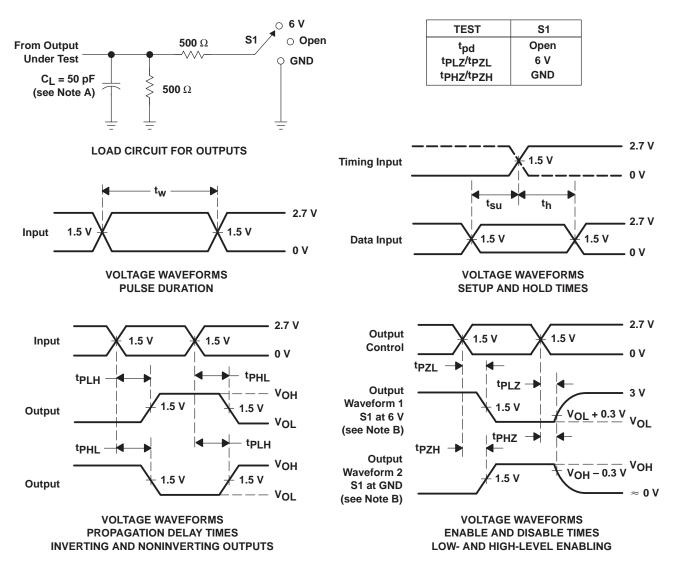
switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	FROM TO TO (INPUT)	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		V _{CC} = 2.7 V		UNIT
FARAMETER	(INPUT)		MIN	MAX	MIN	MAX	UNIT
^t pd	А	Y	1.5	7	1.5	8	ns
ten	OE	Y	1.5	9	1.5	10	ns
^t dis	OE	Y	1.5	7	1.5	8	ns

operating characteristics, V_{CC} = 3.3 V, T_A = 25°C

PARAMETER		TEST CO	TYP	UNIT		
C _{pd}	Power dissinction conscitance per huffer/driver	Outputs enabled	- C _L = 50 pF,	f = 10 MHz	20	~
	Power dissipation capacitance per buffer/driver	Outputs disabled			2	р⊢





PARAMETER MEASUREMENT INFORMATION

- NOTES: A. CL includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.
 Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_Q = 50 Ω , t_f \leq 2.5 ns, t_f \leq 2.5 ns.
 - D. The outputs are measured one at a time with one transition per measurement.
 - E. tpLz and tpHz are the same as tdis.
 - F. t_{PZL} and t_{PZH} are the same as t_{en}.
 - G. tPLH and tPHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms



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